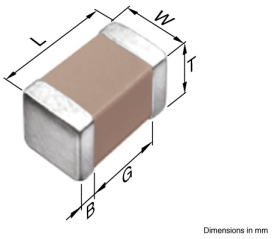
Creation Date : April 24, 2017 (GMT)

Multilayer Ceramic Chip Capacitors

C1608JB0J226M080AC

RoHS | REACH SVHC-Free | Halogen Free | Lead Free

TDK item description	C1608JB0J226MT****
Applications	Commercial Grade
Feature	General (Up to 50V)
Series	C1608 [EIA 0603]
Status	Production



Size	
Length(L)	1.60mm +0.20,-0.10mm
Width(W)	0.80mm +0.20,-0.10mm
Thickness(T)	0.80mm +0.20,-0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering) 0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering) 0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering) 0.60mm to 0.80mm(Reflow Soldering)

Electrical Characteristics	
Capacitance	22µF ±20%
Rated Voltage	6.3VDC
Temperature Characteristic	JB(±10%)
Dissipation Factor (Max.)	10%
Insulation Resistance (Min.)	4MΩ

Other	
Soldering Method	Wave (Flow) Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

! Images are for reference only and show exemplary products.
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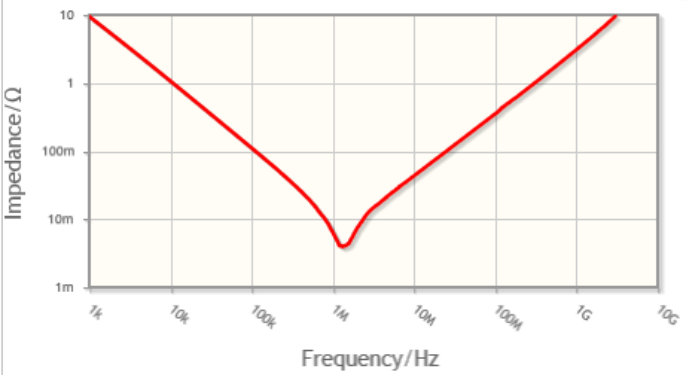
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

Impedance



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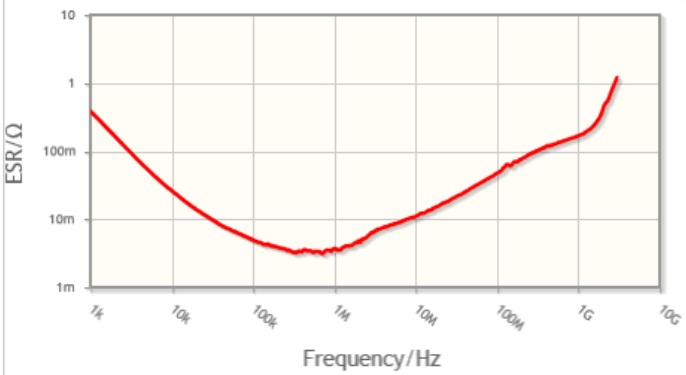
ESR



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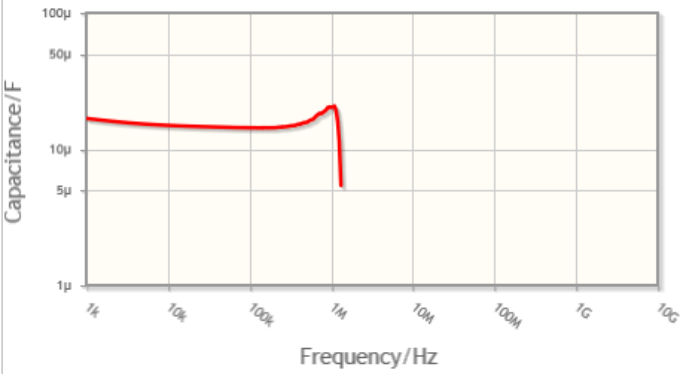
Capacitance



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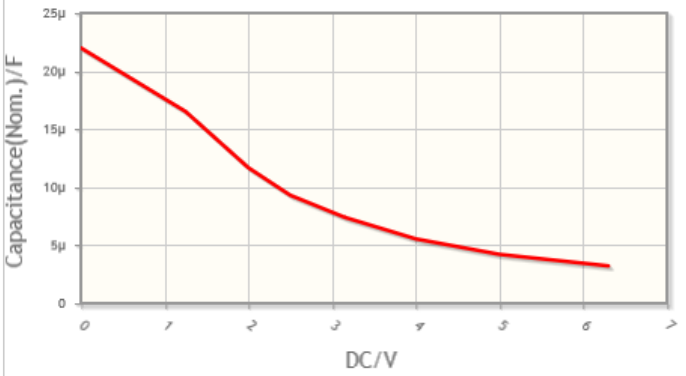
DC Bias Characteristic



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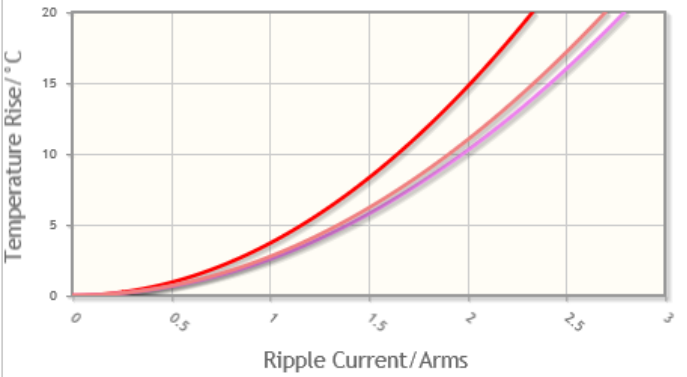
Ripple Temperature Rising



C1608JB0J226M080AC(100kHz) C1608JB0J226M080AC(500kHz) C1608JB0J226M080AC(1MHz)

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Associated Images

Land Pattern (Terminal Connection)

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